





Thermal resistance

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal resistance, junction - case	R _{thJC}	-	-	2.7	C/W
Thermal resistance, junction - ambient	R _{thJA}	-	-	53	C/W
Soldering temperature, wave soldering for 10s	T _{sold}	-	-	265	C



Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
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Fig.13 Resistive Switching Test Circuit

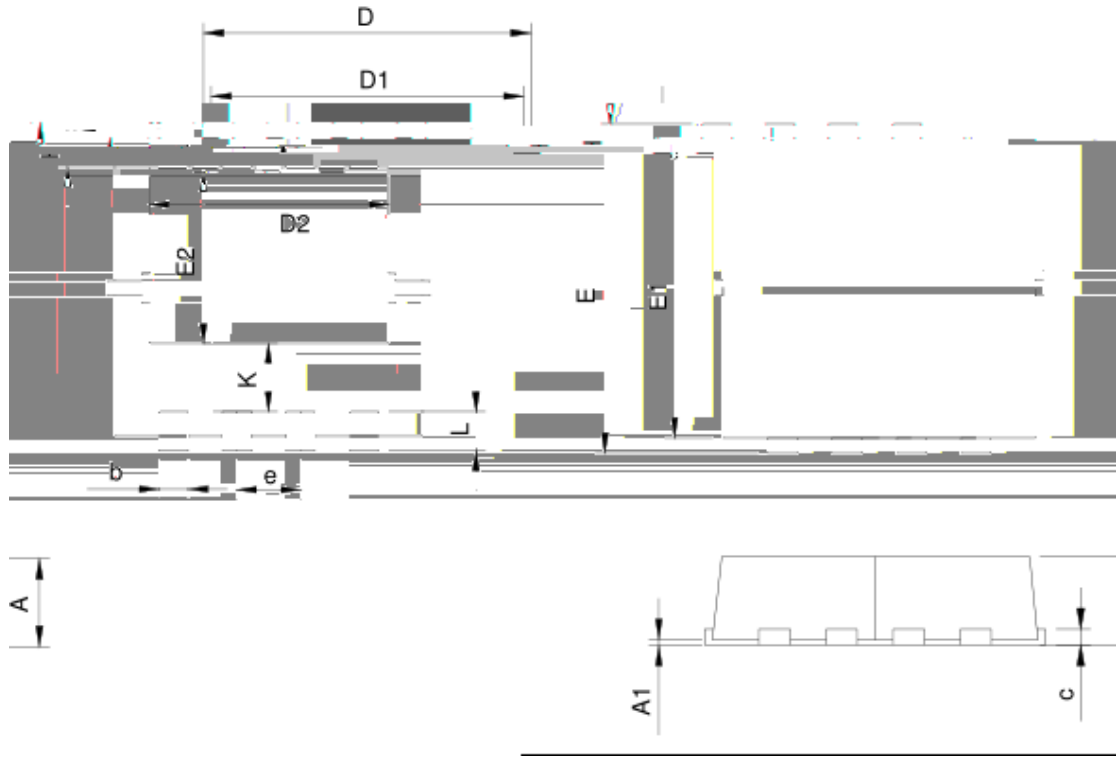
Fig.14 Resistive Switching Test Waveform

Fig.1



(DFN3x3)

Unit mm



DFN3.3x3.3-8		RECOMMENDED LAND PATTERN			
		DIMENSIONS		DIMENSIONS	
		MIN.	MAX.	MIN.	MAX.
A	0.70	1.00	0.028	0.039	
A1	0.00	0.05	0.000	0.002	
b				0.25	0.35
c				0.14	0.20
D	3.10	3.50	0.122	0.122	
D1	3.05	3.25	0.120		
D2	2.35	2.55	0.093	0.100	
E	3.10	3.50	0.122	0.138	
E1	2.90	3.10	0.114	0.122	
E2	1.00	1.64	0.341	0.355	
e		0.65 BSC		0.026 BSC	
H	0.32	0.52	0.013	0.020	
K	0.59	0.79	0.023	0.031	
	0.25	0.35	0.010	0.022	

UNIT: mm